

Description

The SI7114DN-T1-E3 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = 30V I_{D} = 60 A$

 $R_{DS(ON)}$ < 8 m Ω @ V_{GS} =10V

Application

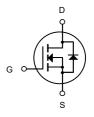
Battery protection

Load switch

Uninterruptible power supply



DFN3X3-8L



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
SI7114DN-T1-E3	DFN3X3-8L	HXY MOSFET	5000

Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Rating	Units
V _D s	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	60	Α
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	20	Α
Іом	Pulsed Drain Current ²	140	А
EAS	Single Pulse Avalanche Energy ³	115.2	mJ
las	Avalanche Current	48	Α
P _D @T _C =25°C	Total Power Dissipation ⁴	59	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R _θ JA	Thermal Resistance Junction-ambient ¹ 62		°C/W
R _θ Jc	Thermal Resistance Junction-Case ¹	2.1	°C/W

N-Channel Enhancement Mode MOSFET

Electrical Characteristics (T_A=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVpss	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
∆BVbss/∆Tj	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.027		V/°C
		V _{GS} =10V , I _D =20A		6	8	
Rds(on)	Static Drain-Source On- Resistance ²	V _{GS} =4.5V , I _D =10A		7.5	10	mΩ
VGS(th)	Gate Threshold Voltage		1.2		2.5	V
$\triangle V_{\text{GS(th)}}$	V _{GS(th)} Temperature Coefficient	V _{GS} =V _{DS} , I _D =250uA		-5.8		mV/°C
lpss	Drain-Source Leakage Current	V_{DS} =24V , V_{GS} =0V , T_J =25°C			1	uA
IDSS	Dialii-Soulce Leakage Guirent	V_{DS} =24V , V_{GS} =0V , T_J =55°C			5	uA
Igss	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		43		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.7		Ω
Qg	Total Gate Charge (4.5V)			20		nC
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , J _D =15A		7.6		
Q_{gd}	Gate-Drain Charge	10-13A		7.2		
Td(on)	Turn-On Delay Time			7.8		
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω		15		
Td(off)	Turn-Off Delay Time			37.3		ns
Tf	Fall Time	_I _D =15A		10.6		
Ciss	Input Capacitance			2295		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V ,		267		pF
Crss	Reverse Transfer Capacitance	_f=1MHz		210		
Is	Continuous Source Current ^{1,6}	V _G =V _D =0V , Force			40	Α
Іѕм	Pulsed Source Current ^{2,6}	Current			140	Α
Vsb	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V

Diode Characteristics

Note

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leqq 300 us$, duty cycle $\leqq 2\%$
- 3 .The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, L\text{=}0.1\text{mH}, I_{\text{AS}}\text{=}34\text{A}$
- 4. The power dissipation is limited by 150 °C junction temperature
- 5 .The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

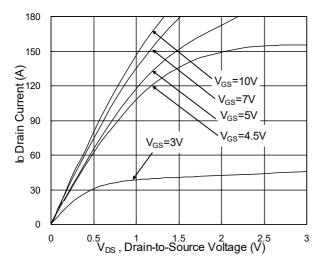


Fig.1 Typical Output Characteristics

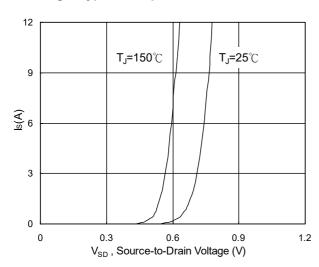


Fig.3 Forward Characteristics of Reverse

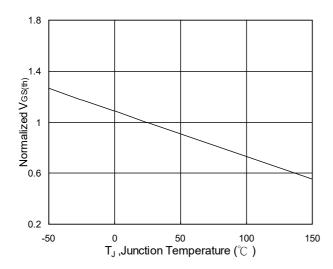


Fig.5 Normalized $V_{\text{GS(th)}}$ vs. T_{J}

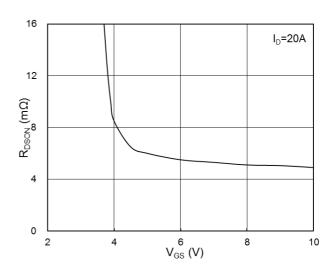


Fig.2 On-Resistance vs. G-S Voltage

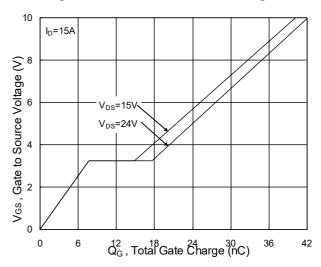


Fig.4 Gate-Charge Characteristics

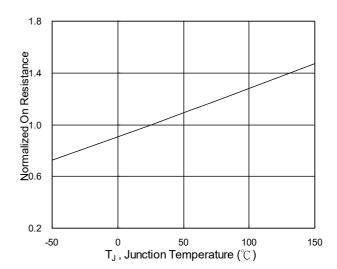
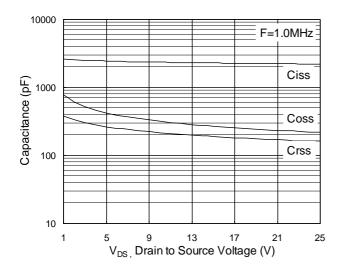


Fig.6 Normalized R_{DSON} vs. T_J



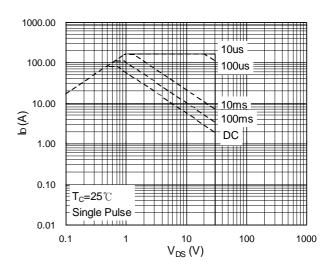


Fig.7 Capacitance

Fig.8 Safe Operating Area

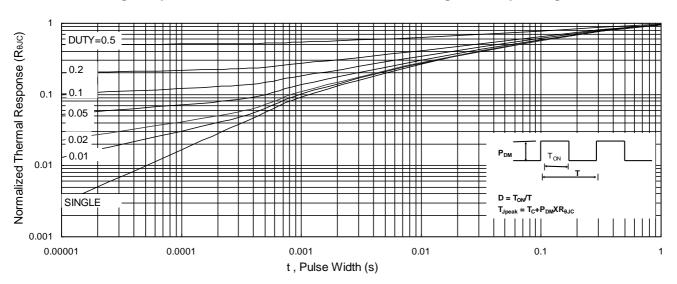


Fig.9 Normalized Maximum Transient Thermal Impedance

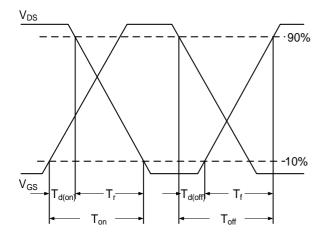


Fig.10 Switching Time Waveform

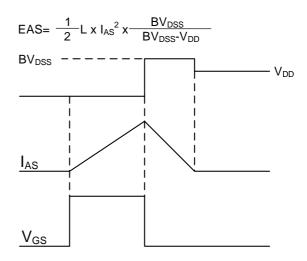
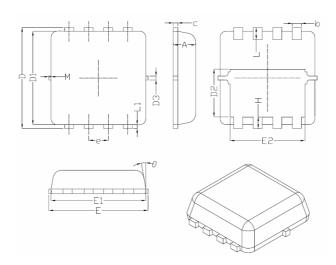


Fig.11 Unclamped Inductive Switching Waveform

DFN3X3-8L Package Information



Sumb al	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
e	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10°	12 [°]	



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BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR
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